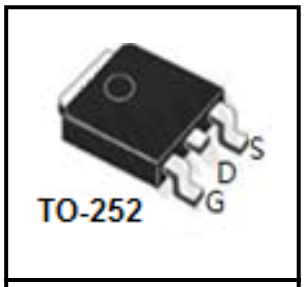
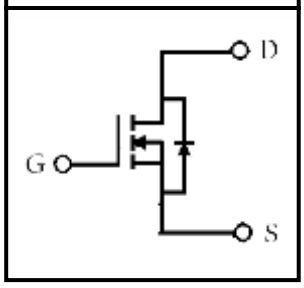
100V N-Channel Trench MOSFET

FEATURES

- Super Low Gate Charge
- 100% EAS Guaranteed
- RoHS compliant
- Green Device Available
- Excellent CdV/dt effect decline
- Advanced high cell density Trench technology





APPLICATIONS

- Power switching application
- LED TV Backlight Module
- LCD Application System

Device Marking and Package Information

Device	Package	Marking
CTD10N100	TO-252	CTD10N100

Absolute Maximum Ratings at T_j= 25ºC unless otherwise noted

Parameter		Symbol	Value	Unit
Drain-Source Voltage (V_{GS} = 0V)		V_{DSS}	100	V
Drain Current-Continuous(Tc =25℃)	(note1)	I_D	17	A
Drain Current-Continuous(Tc =100℃)	(note1)		13	
Pulsed Drain Current	(note2)	I_{DM}	25	A
Gate Source Voltage		V_{GSS}	±20	V
Power Dissipation T_C = 25ºC	(note4)	P_D	30	W
Single Pulse Avalanche Energy	(note3)	E_{AS}	0.8	mJ
Operating Junction and Storage Temperature Range		T_J, T_{stg}	-55~+175	ºC

Thermal Characteristics

Parameter		Symbol	Value	Unit
Thermal Resistance Junction-to-ambient	(note1)	$R_{\theta JA}$	62	℃/W
Thermal Resistance Junction-Case	(note1)	$R_{\theta Jc}$	3.6	℃/W

Electrical Characteristics T_j= 25ºC unless otherwise specified						
Parameter	**Symbol**	**Test Conditions**	**Value**			**Unit**
			Min.	**Typ.**	**Max.**	
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS} = 0V, I_D = 250μA	100	--	--	V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 80V, V_{GS} = 0V, T_J = 25ºC	--	--	1	uA
Zero Gate Voltage Drain Current		V_{DS} = 80V, V_{GS} = 0V, T_J = 55ºC	--	--	5	
Gate-Source Leakage	I_{GSS}	V_{GS} = ±20V	--	--	±100	nA
Gate-Source Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250μA	1.2	--	2.9	V
Drain-Source On-Resistance (note2)	$R_{DS(on)}$	V_{GS} = 10V, I_D = 10A	--	--	100	mΩ
		V_{GS} = 4.5V, I_D = 8A	--	--	110	mΩ
Dynamic						
Input Capacitance	C_{iss}	V_{GS} = 0V, V_{DS} = 50V, f = 1.0MHz	--	450	--	pF
Output Capacitance	C_{oss}		--	55	--	
Reverse Transfer Capacitance	C_{rss}		--	16	--	
Total Gate Charge （4.5V）	Q_g	V_{DS} = 50V, I_D = 15A, V_{GS} = 10V	--	11.9	--	nC
Gate-Source Charge	Q_{gs}		--	2.8	--	
Gate-Drain Charge	Q_{gd}		--	1.7	--	
Turn-on Delay Time	$t_{d(on)}$	V_{DS} = 50V, I_D = 15A V_{GS} = 10V,R_G = 3Ω	--	3.8	--	ns
Turn-on Rise Time	t_r		--	25.8	--	
Turn-off Delay Time	$t_{d(off)}$		--	16	--	
Turn-off Fall Time	t_f		--	8.8	--	
Body Diode Characteristics						
Source-Drain Current(Body Diode)	I_{SD}		--	--	17	A
Pulsed Source-Drain Current(Body Diode)	I_{SDM}		--	--	25	A
Body Diode Voltage	V_{SD}	I_{SD} = 22A, V_{GS} = 0V	--	--	1.2	V

Notes

1. The data tested by surface mounted on a 1 inch2 FR-4 board with 2OZ copper.
2. The data tested by pulsed , pulse width≦300us , duty cycle≦2%
3. The EAS data shows Max. rating . The test condition is VDD =25V,VGS =10V,L=0.1mH
4. The power dissipation is limited by 175℃ junction temperature
5. The data is theoretically the same as ID and IDM , in real applications , should be limited by total power dissipation.

Typical Characteristics T_J = 25ºC, unless otherwise noted

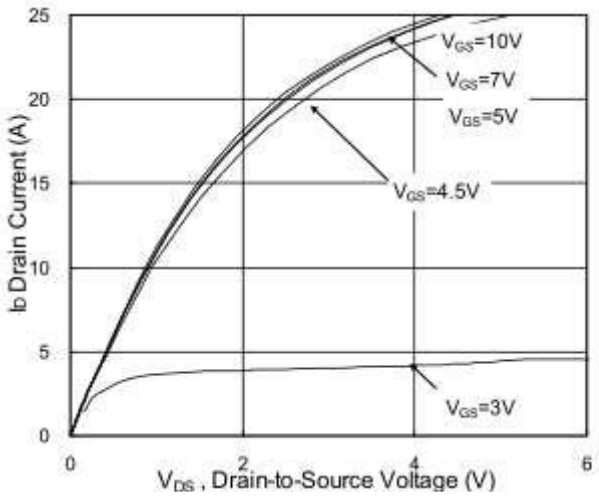


Fig.1 Typical Output Characteristics

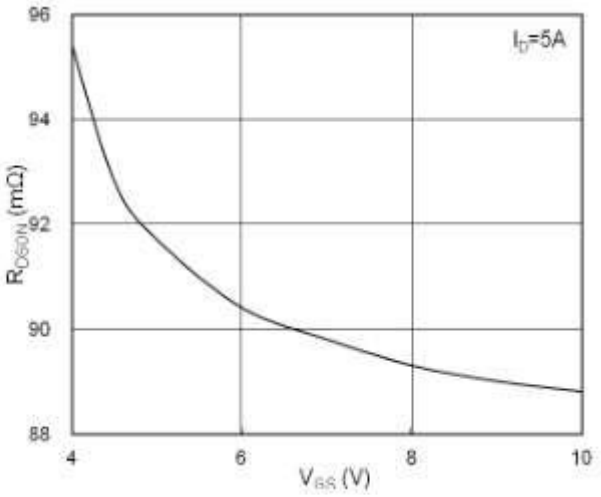
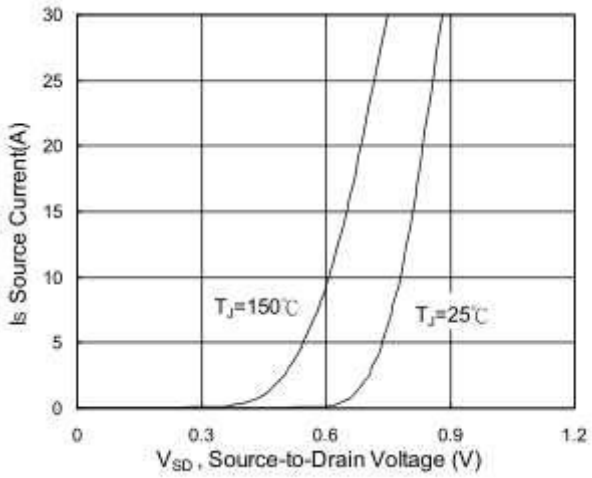


Fig.2 On-Resistance vs. G-S Voltage



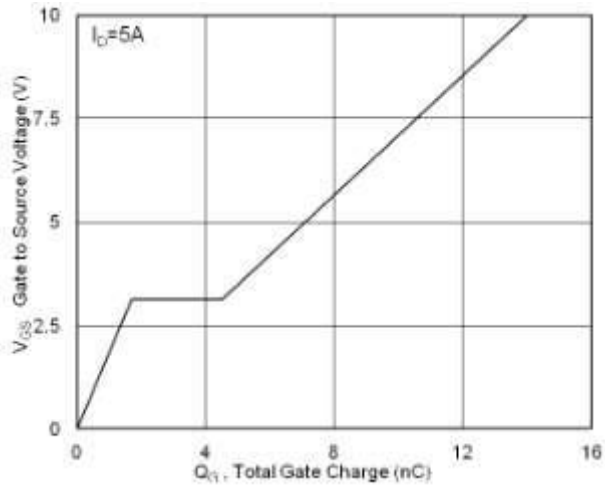
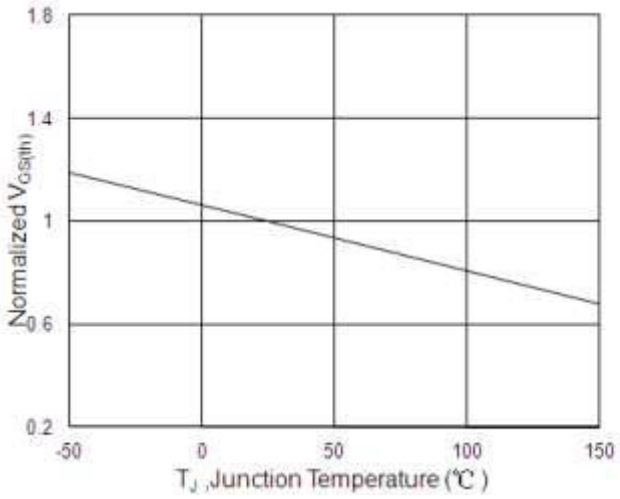


Fig.3 Source Drain Forward Characteristics **Fig.4 Gate-Charge Characteristics**



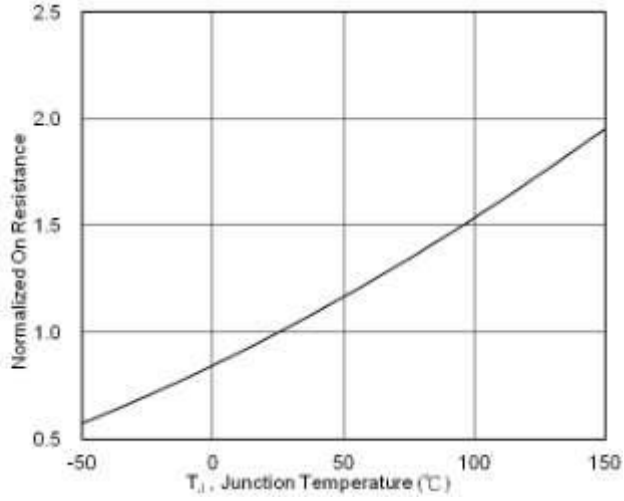


Fig.5 Normalized VGS(th) vs. TJ **Fig.6 Normalized RDSON vs. TJ**

Typical Characteristics T_J = 25ºC, unless otherwise noted

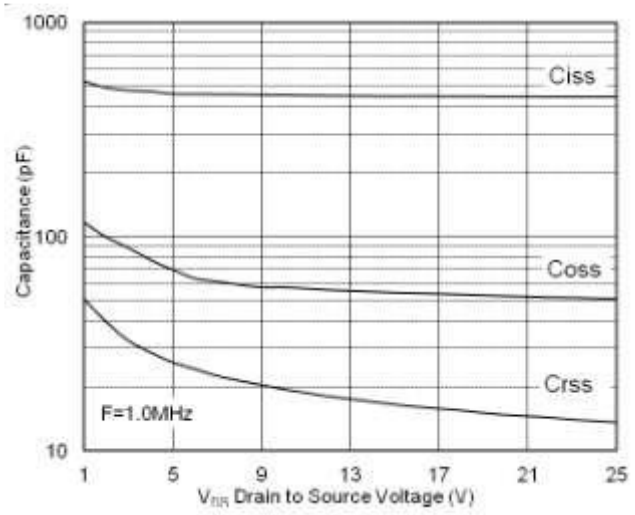


Fig.7 Capacitance

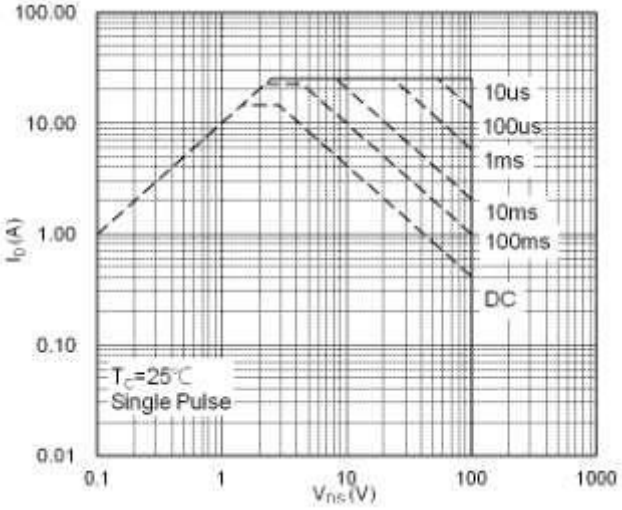


Fig.8 Safe Operating Area

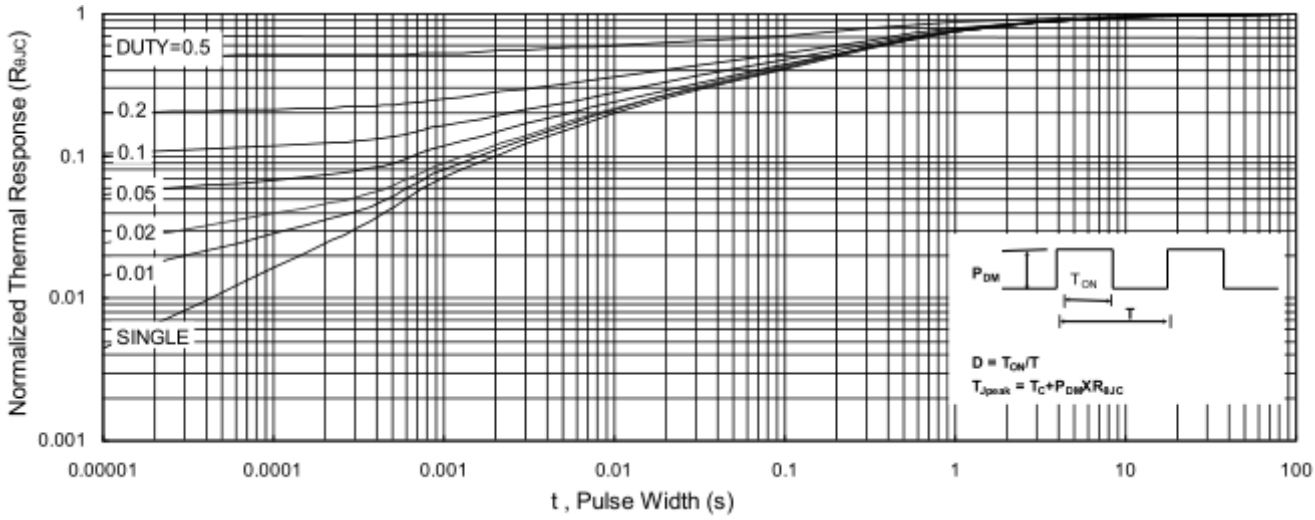


Fig.9 Normalized Maximum Transient Thermal Impedance

Figure A：Gate Charge Test Circuit and Waveform

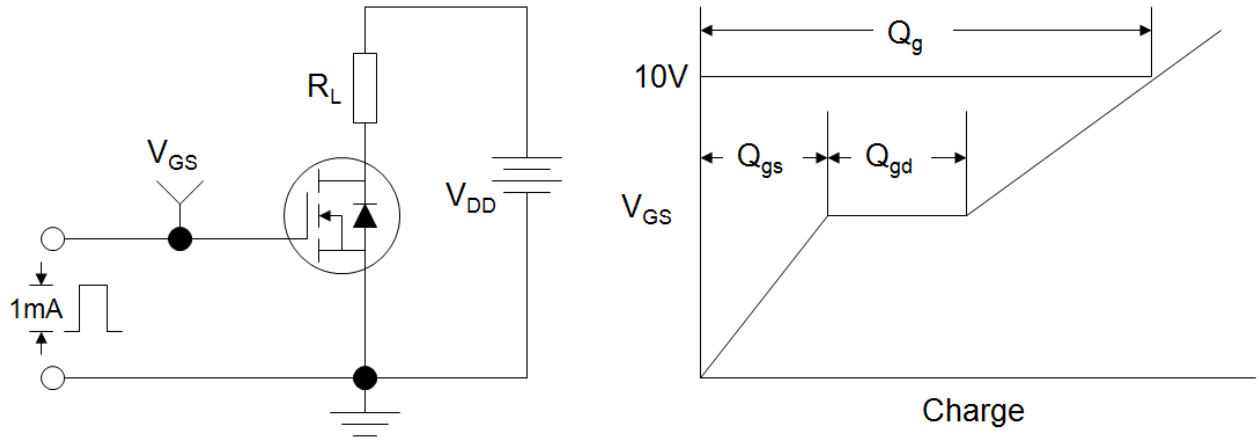


Figure B：Resistive Switching Test Circuit and Waveform

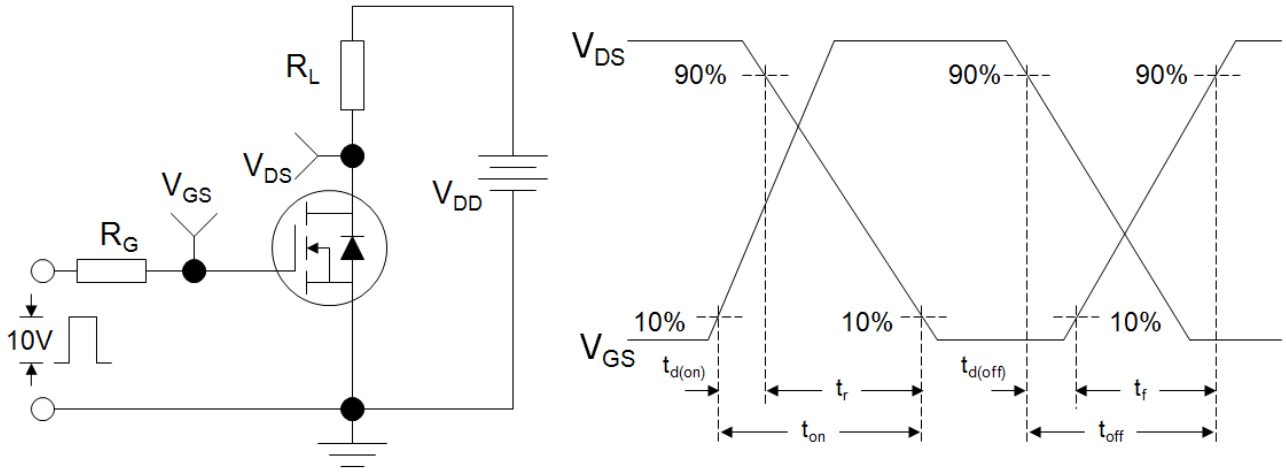
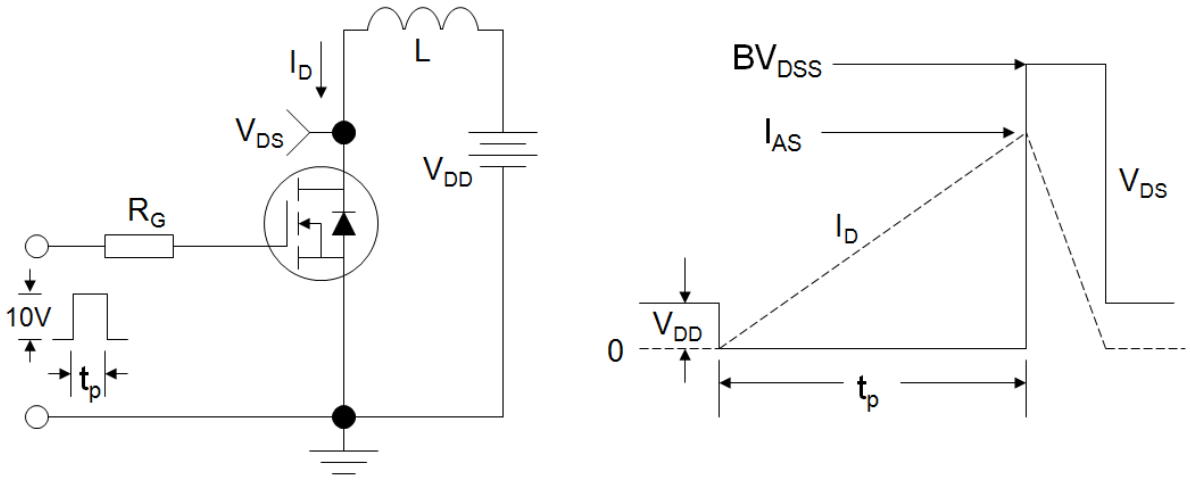
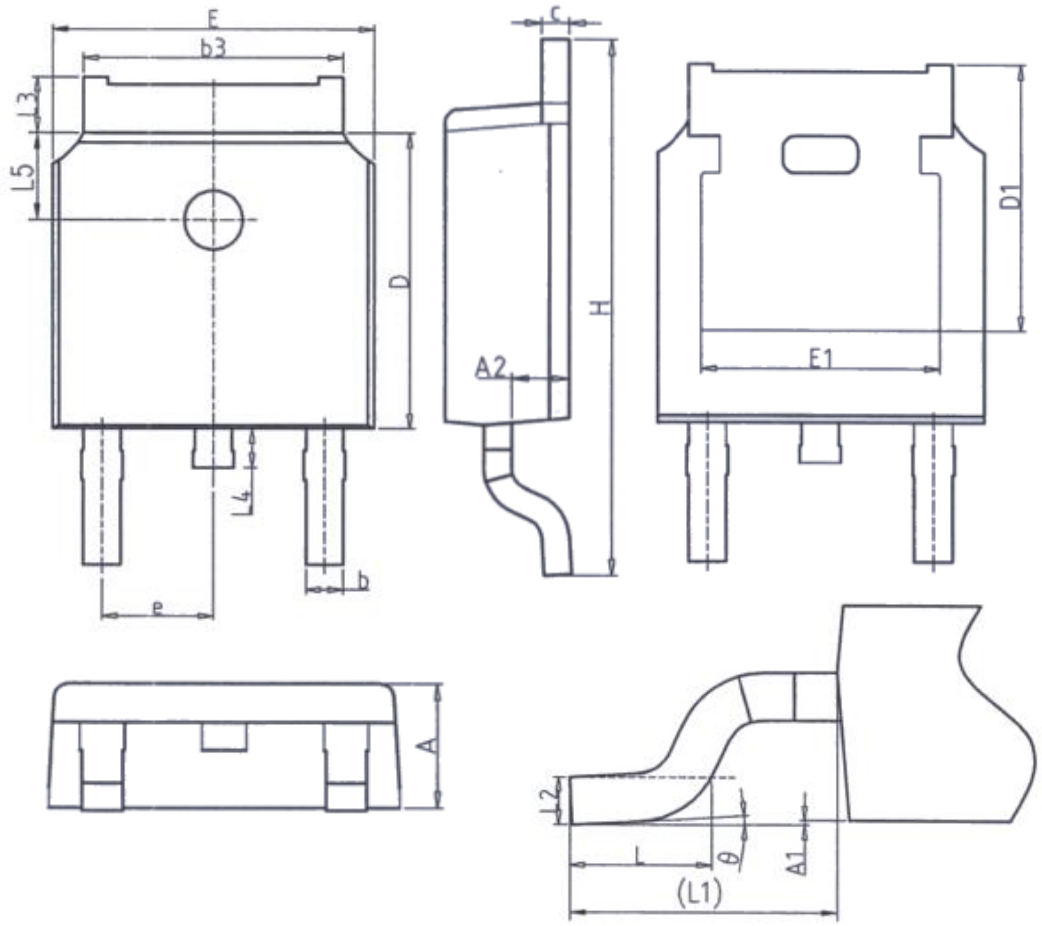


Figure C：Unclamped Inductive Switching Test Circuit and Waveform



TO-252



Unit: mm		
Symbol	Min.	Max.
A	2.20	2.40
A1	0.00	0.20
A2	0.97	1.17
b	0.68	0.90
b3	5.20	5.50
c	0.43	0.63
D	5.98	6.22
D1	5.30REF	
E	6.40	6.80
E1	4.63	–

Unit: mm		
Symbol	Min.	Max.
e	2.286BSC	
H	9.40	10.50
L	1.38	1.75
L1	2.90REF	
L2	0.51BSC	
L3	0.88	1.28
L4	–	1.00
L5	1.65	1.95
θ	0°	8°

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